

GS-BT2416C2

Bluetooth Class 2 Module

Features

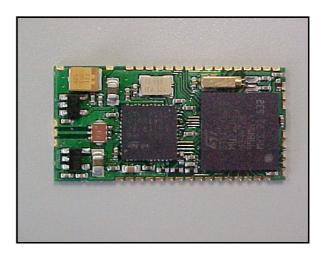
- Bluetooth specification V.1.2 compliant
- Supports USB (1.1) /UART/PCM (Pulse Code Modulation) interfaces
- Bluetooth protocol layers support up to HCI
- Output power class 2
- Optimized link manager and control
- Working distance up to 10 meters
- Support wireless LAN coexistence
- 3.3V single supply voltage
- CE Compliant
 - Safety EN60950-1 (2001)
 - EMC EN301 489 17V1.2.1
 - Radio ES 300 328 V1.6.

Applications

- Personal computers accessories
- Laptop PCs and accessories
- Hand held devices and accessories
- Internet access points
- Industrial controls

Order code

■ GS-BT2416C2



Description

SPG Bluetooth Class 2 Module is a highly integrated module for fast implementation in various applications to enable electronic devices to communicate wirelessly with other Bluetooth enabled devices.

It is a true saver for manufacturers to provide time-to-market products.

With different types of interface, (USB/UART/PCM/SPI/I²C), the module can be used in applications such as Notebook PCs and accessories, PDA, Access Points, Headphones and PC peripherals, etc.

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GS-BT2416C2 Maximum ratings

1 Maximum ratings

1.1 Absolute maximum ratings

Operation of the module beyond these limits is not guaranteed.

Sustained exposure to these limits will adversely affect device reliability.

Table 1. Absolute maximum ratings

Symbol	Parameter	Val	Unit	
	Farameter	Min	Max	O I III
V _{DD}	Module supply voltage		4	V
V _{IN}	Input voltage on any digital pin	Vss1-0.5	Vdd+0.3	V
T _{stg}	Storage temperature	-40	+85	°C
T _{sold}	Soldering temperature		240	

1.2 Operating ranges

Operating ranges define the limits for functional operation and parametrics characteristics of the module.

Functionality outside these limits is not implied

Table 2. Operating ranges

Symbol	Parameter	Conditions		Unit		
	raiametei	Conditions	Min	Тур	Max	Oilit
V _{DD}	Module supply voltage	-20°C < T < 70 °C	3.13	3.3	3.47	V
T _{stg}	Operating ambient temperature		-20		+70	°C

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I/O specification GS-BT2416C2

2 I/O specification

Table 3. DC Input / Output specification

Symbol	Power-ster.	Conditions		Unit		
	Parameter	Conditions	Min	Тур	Max	Oiiit
V _{il}	Low level input voltage	3.13 V < V _{DD} < 3.47 V			0.8	V
V _{ih}	High level input voltage	3.13 V < V _{DD} < 3.47 V	2			V
V _{hyst}	Schmitt trigger hysteresis	3.13 V < V _{DD} < 3.47 V	0.4			V
V _{ol}	Low level output voltage	lo load = pin drive capability			0.15	V
V _{oh}	High level output voltage	lo load = pin drive capability	V _{DD} - 0.15			V

3 Bluetooth section

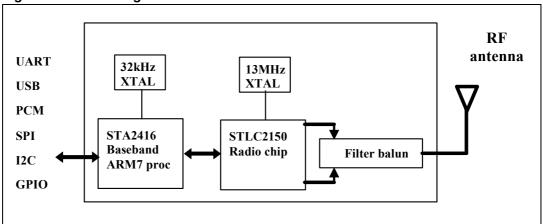
Table 4. Bluetooth section

Symbol	Parameter	Conditions		Unit		
Symbol	Farameter	Conditions	Min	Тур	Max	Onit
P _{tr}	Transmission power	3.13V < V _{DD} < 3.47V		2		dBm
Sens	Sensitivity	3.13V < V _{DD} < 3.47V	-70			dBm
Flim	Frequency limit	3.13V < V _{DD} < 3.47V	2402		2480	MHz
CHs	channel space			1		MHz
Нор	Hopping			1600		hops/ sec
RF ck	RF crystal oscillator			13		MHz
BB ck	Baseband crystal oscillator	C2		32		kHz
Tra	Transmission rate asyncronous				721	kbits/ sec
Trs	Transmission rate syncronous				432	kbits/ sec
lon	Operation current TX mode			90		mA
lop	Operation current RX mode			50		mA

GS-BT2416C2 Block diagram

4 Block diagram

Figure 1. Block diagram



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Pin settings GS-BT2416C2

5 Pin settings

Table 5. Pin description

Table 5	DIE 5. PIN DESCRIPTION				
Pin N°	Name	I/O	Description		
1	TDI		JTAG pin		
2	TMS		JTAG pin		
3	NTRST		JTAG pin		
4	TDO		JTAG pin		
5	TCK		JTAG pin If not used connect to VSS1		
6	INT1	-	External Interrupt signal Internally connected to VSS1 with 10 K Ω If not used connect to VSS1		
7	I2C_dat	I/O	I2C bus interface data To be connected to VDD with 10 K Ω resistor		
8	I2C_clk	I/O	I2C bus interface clock To be connected to VDD with 10 K Ω resistor		
9	PCM_CLK	I/O	PCM clock		
10	PCM_SYNC	I/O	PCM 8kHz synch		
11	PCM_B	I/O	PCM Data In/Out		
12	PCM_A	I/O	PCM Data In//Out		
13	UART2_RXD	I	UART2 data input If not used connect to VDD		
14	UART2_TXD	0	UART2 data output		
15	UART2_I1	O/I	UART2 clear to send input If not used connect to VDD		
16	UART2_02	0	UART1 ready to send output		
17	SPI_FRM	I/O	Syncronous Serial Interface frame synch		
18	SPI_CLK	I/O	Syncronous Serial Interface clock		
19	SPI_TXD	O/T	Syncronous Serial Interface transmit data		
20	SPI_RXD	ı	Syncronous Serial Interface receive data If not used connect to VSS1		
21	USB_DN	I/O	USB data - If not used connect to VSS1		
22	USB_DP	I/O	USB data + If not used connect to VSS1		
23	RESET	I	Reset pin (active low)		
24	BOOT	I	External downloading Enable (active low) Internally pul-upped to 1.8V by 10kohm		
25	GPIO0	I/O	General purpose I/O line		

GS-BT2416C2 Pin settings

Table 5. Pin description (continued)

Pin N°	Name	I/O	Description
26	GPIO1	I/O	General purpose I/O line
27	GPIO2	I/O	General purpose I/O line
28	GPIO3	I/O	General purpose I/O line
29	GPIO4	I/O	General purpose I/O line
30	GPIO5	I/O	General purpose I/O line
31	GPIO6	I/O	General purpose I/O line
32	GPIO7	I/O	General purpose I/O line
33	GPIO8	I/O	General purpose I/O line
34	GPIO9	I/O	General purpose I/O line
35	LP CLOCK OUT		32 kHz - out
36	GPIO11	I/O	General purpose I/O line
37	GPIO12	I/O	General purpose I/O line
38	GPIO13	I/O	General purpose I/O line
39	GPIO14	I/O	General purpose I/O line
40	GPIO15	I/O	General purpose I/O line
41	Vdd		Module supply voltage- Single 3.3V
42	Vss1		GND
43	Vss2 (RF GND)		RF GND
44	+ANTENNA		Antenna out
45	Vss2 (RF GND)		RF GND

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Mechanical dimensions GS-BT2416C2

6 **Mechanical dimensions**

Figure 2. **Mechanical dimensions**

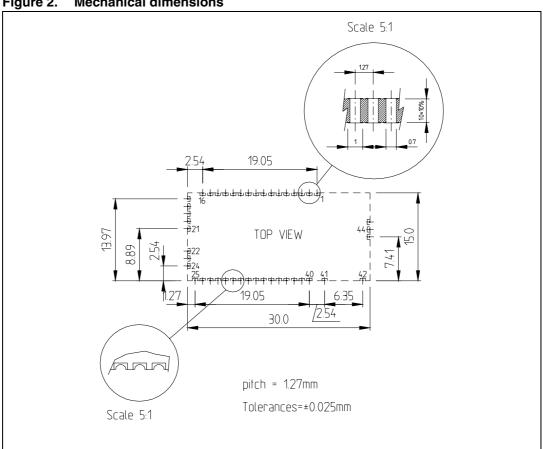
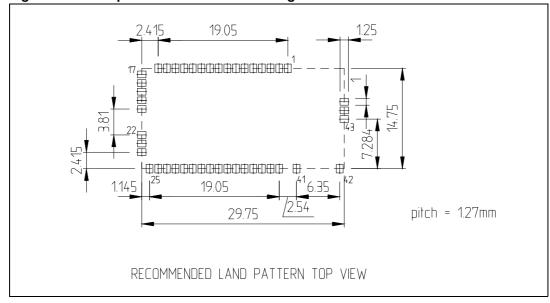


Figure 3. Land pattern and connection diagram



GS-BT2416C2 Revision history

7 Revision history

Table 6. Revision history

Date	Revision	Changes
20-Dec-2006	1	First release
28-Feb-2007 2		Typo Table 5: Pin description on page 6

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